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ISO9001 International Quality Management System Certification IS014001 International Environmental Management System Certification

The Largest Adhesive R&D Manufacturer in China

 Six production bases cover Shanghai, Guangzhou, Changzhou, Xiangyang and Yicheng, and total floor area exceeds 1,200,000 m²



About US

Huitian New Material (stock code: 300041) is the sole enterprise of Chinese adhesive new material industry with the longest history and most categories. With 46 years of development history, Huitian focuses on the research and development of adhesive new materials and owns over 2,000 products in six major disciplines. These products are widely used in fields such as photovoltaic new energy, new energy automobile, 5G communications, consumer electronics, aviation & aerospace and others, providing comprehensive solutions for adhesive new materials.

Huitian is the sole enterprise of Chinese adhesive new material industry with the widest layout and highest research and development investment. It has established five major research and development bases in Shanghai, Guangzhou, Xiangyang, Yicheng, and Changzhou, as well as industrial bases in Vietnam. Huitian has a core research and development team of over 300 people, including doctors and masters, and has obtained more than 300 patented technologies. It is the first "National Enterprise Technology Center" in the domestic adhesive new material industry.

Huitian is the sole enterprise of Chinese adhesive new material industry focusing on core tracks and fully replacing import enterprises. It has established strategic cooperation with benchmark customers in three core tracks: photovoltaic new energy, lithium battery industry and communication electronics, such as Huawei, CATL, LONGi and Nissan, making it the preferred brand for domestic replacement of adhesive new materials.

Huitian is the sole enterprise of Chinese adhesive new material industry with sustained growth and the strongest development momentum. Its performance has continued to grow steadily over the 13 years since its listing, effectively promoting the development of national adhesive new materials. Huitian has always adhered to the mission of "serving the industry and society", striving to empower employees, satisfy customers, achieve win-win partnerships, increase shareholder value, and gain trust from society, thus contributing to the dignity of national enterprises.



Huitian Introduction

Layout

Electrical Product Law Full Range of Adhesiv

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Electric Product Layout of New Energy Automobile

Complete Adhesive Product Solution













- **«** Silicone
- « PU/PUR
- « Epoxy
- « UV
- « MS
- « Acrylic acid



() 回天新材 Charging Gun

05



Charging Gun



Potting Protection 8252 Series

The charging gun after potting protection can improve the electrical and electronic performance to reach the anti-rolling, water-proof, insulating and flame retarding effect.

- ♦ Fast curing in normal temperature
- ♦ High adhesion strength
- ♦ Excellent electrical performance



★ Potting Adhesive for Charging Gun

Product Name	Appearance	Viscosity mPa•s	Density g/cm³	Mix Ratio	Operating Time min	Initial Curing Time h	Hardness (Shore D)	Thermal Conductivity W/(m•K)	Flame Retardant Rating (UL94)
Part A 8252H Part B	Black Light brown	12,500-14,500 2,900-3,500	1.50-1.56 1.38-14.2	5:1	4-6	1-4	40-50	0.7	V-0(4mm)
8252L Part A Part B	Black Light brown	6,500-7,800 100-170	1.55-1.60 1.22-1.24	5:1	4-6	1-4	60-70	0.6	V-0(4mm)



Shallow Potting 52XX Series

It is applied in coastal area, metallurgy, coal mine, electroplating and other extreme environment or scene to avoid the invasion of water steam and dust.

- ♦ High mobility
- ♦ Anti-poisoning
- ♦ Excellent heat-conducting property, adaptive to higher power module



★ Shallow Potting Adhesive of Charging Module

Produ Nan	uct 1e	Appearance	Viscosity mPa•s	Mix Ratio	Density g/cm³	Thermal Conductivity W/(m•K)	Hardness (Shore A)	Operating Time min	Curing Condition	Dielectric Strength kV/mm
5280	Part A	Gray	2,000~3,500	1.1	1.80	>0.6	20-40	>60	80°C	>14
5200	Part B	White	2,000~3,500	1.1	1.00	20.0	20-40	_00	30min	-17
5000	Part A	Gray	2,000~3,000	1.1	1.50		50 (0	>70	80°C	> 20
5299	Part B	White	1,800~3,000	1:1	1.59	≥0.6	50-60	≥/0	30min	≥20
	Part A	Gray	4,500~7,500		2.75	2.0	20.45	> (0	80°C	> 12
5290D	Part B	White	4,000~7,000	1:1	2.75	2.0	30-45	≥00	30min	≥13

★ Fixing / Dam Adhesive of Charging Module

Product Name	Appearance	Density g/cm³	Thixotropy	Thermal Conductivity W/(m•K)	Hardness (Shore A)	Shear Strength MPa	Dielectric Strength kV/mm	Flame Retardant Rating (UL94)
9765C	White paste	1.70-1.85	3-5	0.8	75-85	2.0	≥18	UL94 V-0







One-part Fixing / Dam Adhesive 9765C

- ♦ High extruding
- ♦ High Aspect Ratio (H/W)
- ♦ No toxic reaction to the addition-type potting glue



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On-board Power Supply (DC-DC、OBC)



Magnetic Device Heat Conducting and Protection 529X Series

Huitian potting adhesive integrating the structural and thermal characteristics of magnetic devices can be tailored to match products with different modulus and heat-conducting property. It can provide good protection and thermal insulation for devices, such as inductors and transformers, effectively preventing problems such as core cracking and excessive temperature rise.

- ♦ 1.0~4.0W/(m-K) products are optional
- ♦ Low modulus and low CTE
- ♦ Self-adhesion
- ♦ Anti-poisoning

Technical **Parameters**

★ Shell Sealant FIPG

Shell Sealing FIPG: 9661 Series

- ♦ Universality for substrate
- ♦ High adhesion strength and elongation at break
- ♦ No corrosion to substrate

Power device heat conducting 2.0-6.0W/ (m.K) Thermal Gel Series

With the increasing power density of devices, the heat generated during operation also increases. Coating the interface between heating device and heat sink with thermal gel can effectively improve the heat conducting efficiency and prevent making damage to device caused by excessive temperature rise.

- ♦ High extruding and good workability
- ♦ Low oil extraction rate
- ♦ Excellent insulation performance
- ♦ High reliability



Technical Parameters

★ One-part Thermal Gel of Power Device On-board Power Supply

Product Name	Appearance	Extruding g/min	Density g/cm ³	Thermal Conductivity W/(m•K)	40psi Interface Thickness mm	40PSI Thermal Resistance °C•cm²/W	Dielectric Strength kV/m	Volume Resistivity Ω•cm
9503	Blue	40	2.1	2.0	0.120	0.701	≥5	$\geq 1 \times 10^{12}$
9503L (Post-cured type)	Pink	120	2.9	3.0	0.022	0.11	≥6	≥1×10 ¹³
9504	Pink	30	3.2	4.0	0.100	0.37	≥6	$\geq 1 \times 10^{13}$
9506	Blue	30	3.4	6.0	0.085	0.18	≥4	≥1×10 ¹²

★ Dual-component Thermal Gel of Power Device On-board Power Supply

Pro Na	duct ime	Appearance	Viscosity Pa•s	Curing Condition	Density g/cm³	Thermal Conductivity W/(m•K)	40PSI Thermal Resistance °C•cm²/W	Hardness (Shore 00)	Elongation at Break %	Dielectric Strength kV/m
5272	Part A	White paste	150-200	80°C	28	2.5	0.60	50	0.40	10
5212	Part B	Blue paste	150-200	30min	2.8	2.5	0.00	30	0.40	10
5274	Part A	Blue paste	150-250	120°C	3.2	2.9	0.55	50	0.25	0
5274	Part B	White paste	150-250	20min	5.2	3.0	0.55	30	0.25	9
5276	Part A	White paste	400	60°C	33	6.0	0.41	60	0.35	0
5270	Part B	Blue paste	500	30min	5.5	0.0	0.41	00	0.55	3

★ Thermal Potting Adhesive of Magnetic Device

Pro Na	duct me	Appearance	Viscosity mPa•s	Density	Thermal Conductivity W/(m•K)	Hardness (Shore A)	Dielectric Strength kV/mm	Volume Resistivity Ω•cm
5296	Part A Part B	Gray White	2,800-4,800	1.95	1.0	30-40	≥18	≥1.0×10 ¹⁴
5297G	Part A Part B	Gray White	2,000-4,000 1,500-3,500	2.52 2.52	1.5	Shore 00 50-60	≥16	≥1.0×10 ¹³
5297C	Part A Part B	Gray White	5,500±2,000 5,000±2,000	2.65 2.65	1.7	10~20	≥16	≥1.0×10 ¹²
5290G	Part A Part B	Pink White	4,500-7,500 4,000-7,000	2.75 2.75	2.0	5-15	≥16	≥1.0×10 ¹⁴
5294G	Part A Part B	Pink White	14,000-22,000 14,000-22,000	3.15 3.15	4.0	Shore 00 40~70	≥10	≥1.0×10 ¹²





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Motor controller



Technical Parameters

★ Shell Sealant (CIPG)

Products	Curing Condition	Appearance	Density g/cm³	Hardness (Shore A)	Shear Strength AI 6061 MPa	Shear Strength PBT+30GF MPa	Tension Strength MPa	Elongation at Break %
9516	150°C/30Min 130°C/60Min	Grey paste	1.1	49	3.4	2.2	4.7	400

Shell Sealing CIPG: 9516

• Resistant to multiple medium oils

compared with silicone grease.

♦ High heat conductivity: 4.0W/(m.K)

♦ Low thermal resistance: 0.07°C-cm²/W

♦ It can significantly improve pump-out problem

♦ Excellent resilience

9504LH

♦ It can be assembled and disassembled repeatedly

Power Device Heat Conducting

It is used for interface heat dissipation between IGBT module baseplate and liquid cooling plate. The operation process and BLT can be comparable to silicone thermal grease, and its reliability is improved greatly

★ Power Device Thermal Gel

Product Name	Appear E -ance	xtruding g/min	Density g/cm ³	Curing Condition	Thermal Conductivity W/(m•K)	40psi Interface Thickness mm	40PSI Thermal Resistance °C•cm²/W	Dielectric Strength kV/m	Volume Resistivity Ω•cm
9504LH	Light green	50	3.2	125°C heating platform 10min	4.0	0.012	0.07	≥6	≥1×10 ¹³

Shell Adhesion 9516FW

- ♦ Heating and fast curing
- ♦ High adhesion strength
- ♦ Friendly matching with potting adhesive



★ IGBT Shell Sealing Adhesive

Product Name	Appearance	Viscosity Pa•s	Density g/cm³	Curing Time	Hardness (Shore A)	Tension Strength MPa	Elongation at Break %	Shear Strength MPa
9516FW	White paste	120~250	1.1	120°C/1h	35	4.5	350	4.0

★ IGBT Potting Adhesive

Pro Na	oduct ame	Appearance	Viscosity mPa•s	Density g/cm³	Curing Condition	Cone Penetration 1/10 mm	Dielectric Constant 1.2MHz	Dielectric Strength kV/mm	Volume Resistivity Ω•cm	Long-term Working Temperature °C	
52000	Part A	Transparent	500-1,500	0.97	80°C	Whole cone	26	> 20	> 11015	50, 150	
5298C	Part B	Transparent	500-1,500	0.97	30-60min	250-350	2.0	<u>≥</u> 20	≥1×10 ¹⁵	-50~150	
	Part A	Transparent	300-600	0.98	80°C	1/2 cone	0.5				
5298D	Part B	Transparent	300-600	0.98	30-60min	130-230	2.5	≥20	≥1×10 ¹⁵	-50~175	
5209E	Part A	Transparent	300-600	0.99	80°C 30-60min	1/2 cone	2.6	>20	>1×1015	50, 200	
3298E	Part B	Light brown	300-600	0.99	100°C 20-40min	130-230	2.0	220	21×10	-50~200	

- Motor controller 🔘 回天新材

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Encapsulation Gel 5298 Series

IGBT modules, as the core part of motor controllers in new energy automobiles, play a crucial role in power control. The sealing adhesive is used and can enable chip with anti-vibration and insulation effects, enhancing the overall waterproof and anti-condensation performance of module.

- ♦ Extremely low modulus
- ♦ Self-adhesion
- ♦ High insulating
- Excellent heat resistance Excellent heat resistance



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Drive motor



Stator / Rotor Potting 6312T

- ♦ Good mobility
- ♦ The product has excellent heat resistance
- ♦ Good solvent resistance

Magnetic Steel Bonding Adhesive 6065 Series

- ♦ One-part heating and curing
- \blacklozenge High adhesion strength
- ♦ Excellent heat resistance

Universal Adhesive



★ Conformal Coating (UV+ Moisture)

Product Name	Appearance	Viscosity mPa•s	Solid Content %	Curing Energy J/cm ²	Dielectric Strength kV/mm	Volume Resistivity Ω•cm	Working Temperature °C	Reworkability
361216	Amber and transparent	100	>99.5%	1-3	≥25	≥10 ¹⁴	-65~150	During the process of using three proofing glue, the
3610H3	Amber and transparent	300	>99.5%	1-3	≥25	≥10 ¹⁴	-65~150	can be used for cleaning
3612H6	Amber and transparent	600	>99.5%	1-3	≥25	≥10 ¹⁴	-65~150	After curing, the paint film can be removed with the highly effective repairing agent 1060

Technical Parameters

★ Stator / Rotor Potting Adhesive

Product Name	Appearance	Viscosity mPa•s	Density	Ratio	Mixed Viscosity mPa•s	Curing Condition	Dielectric Strength kV/mm	Volume Resistivity Ω•cm	Thermal Conductivity W/(m•K)	Working Temperature °C
6312T	Part A black	12,000-20,000	1.70	100.12	1,000-3,000	60°C/3h	≥20	≥1.0×10 ¹⁴	≥0.6	-40~155
	Part B light yellow	30-90	0.98	100:13						

★ Magnetic Steel Bonding Adhesive

Product Name	Appearance	Viscosity mPa•s	Density g/cm³	Curing Condition	Hardness (Shore D)	Shear Strength MPa	Working Temperature ℃
6065	Grey paste	550,000	1.55	120°C/30min 150°C/15min	≥75	≥18	-40~150
6065H	Grey paste	120,000	1.73	120°C/40min 150°C/15min 180°C/10min	≥75	≥10	-40~200

\bigstar Heat conducting and fixing adhesive solution

Product Name	Appearance	Viscosity mPa•s	Thixotropic Index	Thermal Conductivity W/(m•K)	Density g/cm³	Surface Dry Time min	Hardness (Shore D)	Shear Strength MPa	Working Temperature °C
9661E	Grey / white paste	30,000-50,000	3.0-4.0	0.6	1.75	5~15	65-76	≥2.0	-40~150
9765	White slumping fluid	4,500-55,000	2.5-3.5	1.0	1.85	5~10	65-85	≥2.0	-40~150
9665ET	White microflow	60,000-120,000	3.0-4.0	2.0	2.7	1~5	75-95	≥2.0	-40~150

★ Silicone thermal grease

Product Name	Appearance	Viscosity mPa•s	Density g/cm³	Thermal Conductivity W/(m•K)	Thermal Resistance 0.1mm	Cone Penetration 1/10cm	Working Temperature ℃	Product Characteristics
0112	White	200,000	2.6	1.5	0.3	340	-40~150	Easy for paint coating, and low oil leakage
0116Y	Blue	140,000	3.1	3.2	0.11	290	-40~150	High heat conductivity, and easy for paint coating
0117	White	120,000	3.3	4.0	0.07	290	-40~150	High heat conductivity, and good insulativity

